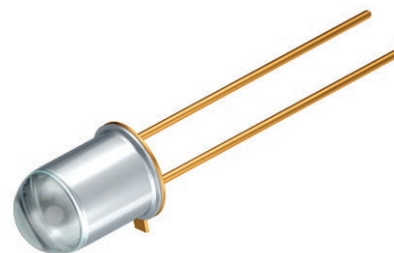


Metal Can TO18

SFH 4855

Infrared Emitter (850 nm)



Applications

- Factory Automation

Features

- Package: hermetically sealed
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Wavelength 850nm
- Short switching times
- Spectral match with silicon photodetectors

Ordering Information

Type	Radiant intensity ¹⁾²⁾ $I_F = 100 \text{ mA}; t_p = 20 \text{ ms}$ I_e	Radiant intensity ¹⁾ typ. $I_F = 100 \text{ mA}; t_p = 20 \text{ ms}$ I_e	Ordering Code
SFH 4855	45 ... 280 mW/sr	110 mW/sr	Q65111A6128
SFH 4855-VAW	71 ... 180 mW/sr	110 mW/sr	Q65111A9675

Maximum Ratings

 $T_A = 25\text{ °C}$

Parameter	Symbol	Values
Operating temperature	T_{op}	min. -40 °C max. 125 °C
Storage temperature	T_{stg}	min. -40 °C max. 125 °C
Junction temperature	T_j	max. 125 °C
Forward current	I_F	max. 100 mA
Forward current pulsed $t_p \leq 200\text{ }\mu\text{s}$; $D \leq 0.005$	$I_{F\text{ pulse}}$	max. 1 mA
Reverse voltage ³⁾	V_R	max. 5 V
Power consumption	P_{tot}	max. 200 mW
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}	max. 2 kV

Characteristics

$I_F = 100 \text{ mA}$; $t_p = 20 \text{ ms}$; $T_A = 25 \text{ °C}$

Parameter	Symbol		Values
Peak wavelength	λ_{peak}	typ.	860 nm
Centroid wavelength	$\lambda_{\text{centroid}}$	typ.	850 nm
Spectral bandwidth at 50% $I_{\text{rel,max}}$ (FWHM)	$\Delta\lambda$	typ.	30 nm
Half angle	φ	typ.	8 °
Dimensions of active chip area	L x W	typ.	0.3 x 0.3 mm x mm
Distance chip surface to lens top	H	min. max.	4 mm 4.8 mm
Rise time (10% / 90%) $I_F = 100 \text{ mA}$; $R_L = 50 \text{ } \Omega$	t_r	typ.	12 ns
Fall time (10% / 90%) $I_F = 100 \text{ mA}$; $R_L = 50 \text{ } \Omega$	t_f	typ.	12 ns
Forward voltage ⁴⁾	V_F	typ. max.	1.7 V 1.9 V
Forward voltage ⁴⁾ $I_F = 1 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	V_F	typ. max.	3.6 V 4.5 V
Reverse current ³⁾ $V_R = 5 \text{ V}$	I_R	typ. max.	0.01 μA 10 μA
Radiant intensity ¹⁾ $I_F = 1 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	I_e	typ.	515 mW/sr
Total radiant flux ⁵⁾ $I_F = 100 \text{ mA}$; $t_p = 20 \text{ ms}$	Φ_e	typ.	35 mW
Temperature coefficient of voltage	TC_V	typ.	-0.6 mV / K
Temperature coefficient of brightness	TC_I	typ.	-0.3 % / K
Temperature coefficient of wavelength	TC_λ	typ.	0.3 nm / K
Thermal resistance junction case real	R_{thJC}	max.	350 K / W
Thermal resistance junction ambient real	R_{thJA}	max.	500 K / W

Brightness Groups

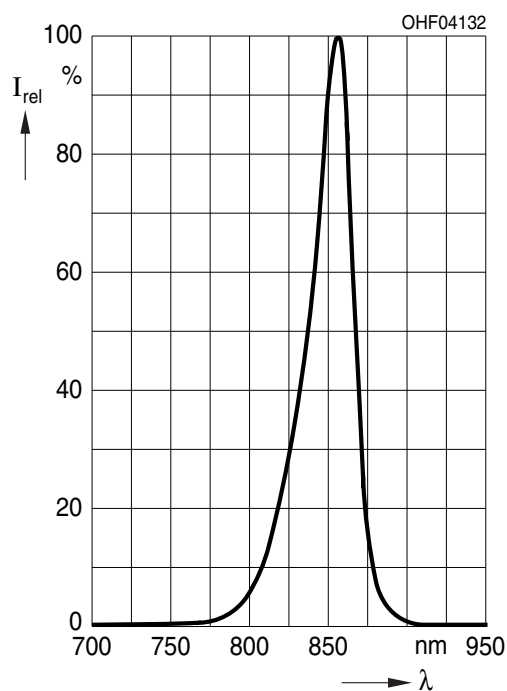
$T_A = 25\text{ °C}$

Group	Radiant intensity ¹⁾²⁾ $I_F = 100\text{ mA}; t_p = 20\text{ ms}$ min. I_e	Radiant intensity ¹⁾²⁾ $I_F = 100\text{ mA}; t_p = 20\text{ ms}$ max. I_e
U	45 mW/sr	71 mW/sr
V	71 mW/sr	112 mW/sr
AW	112 mW/sr	180 mW/sr
BW	180 mW/sr	280 mW/sr

Only one group in one packing unit.

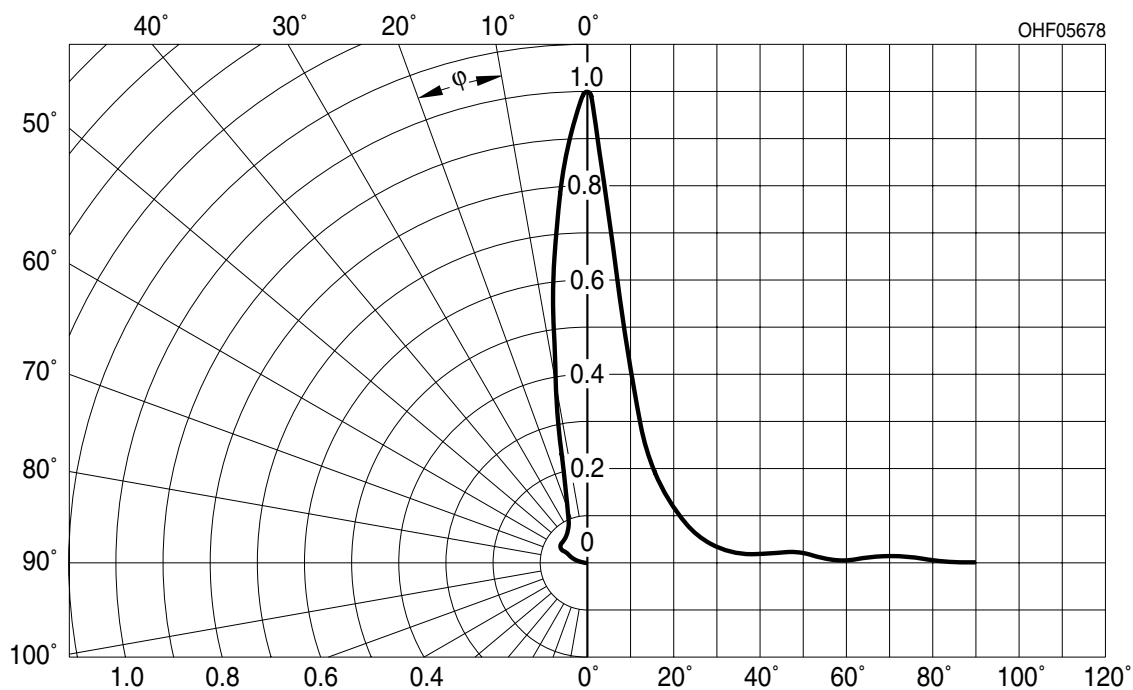
Relative Spectral Emission ^{6), 7)}

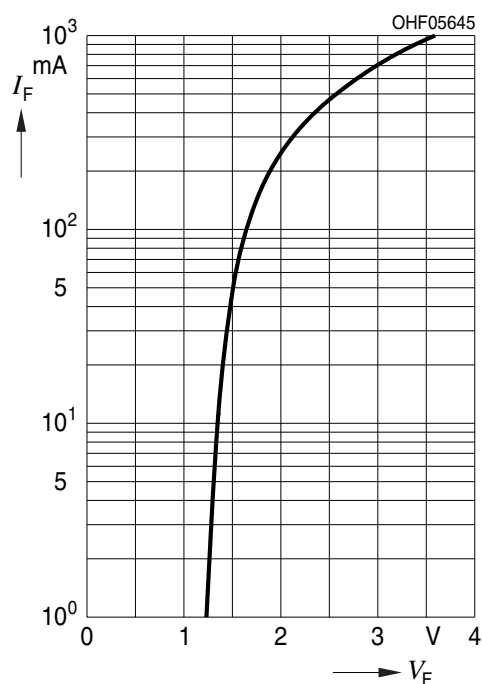
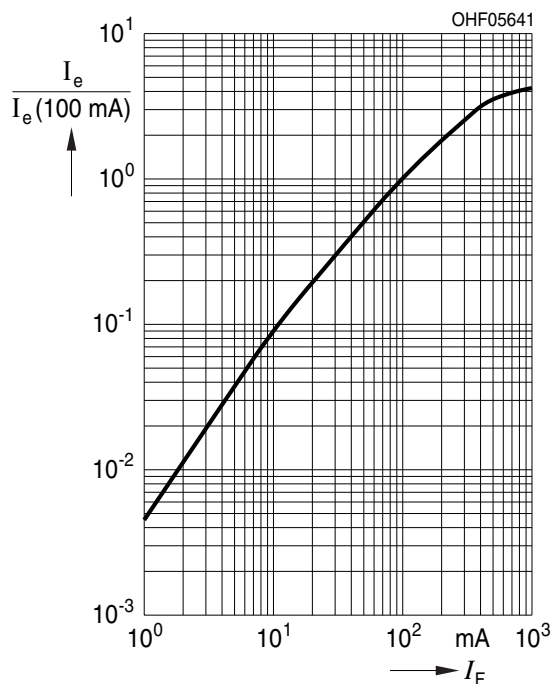
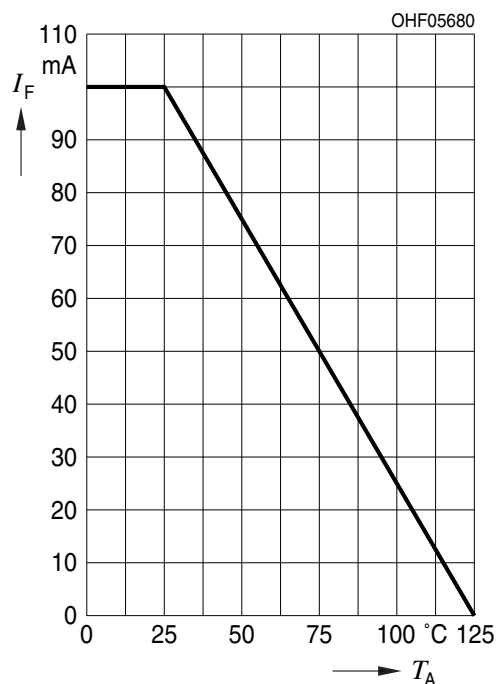
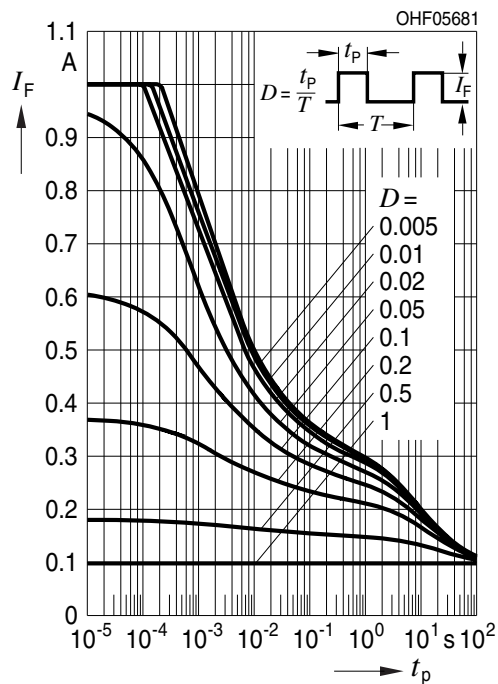
$$I_{e,rel} = f(\lambda); I_F = 100 \text{ mA}; t_p = 20 \text{ ms}$$



Radiation Characteristics ^{6), 7)}

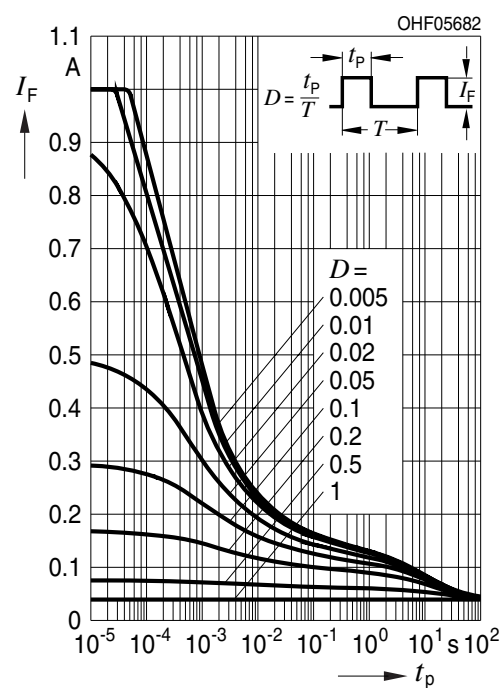
$$I_{e,rel} = f(\varphi)$$



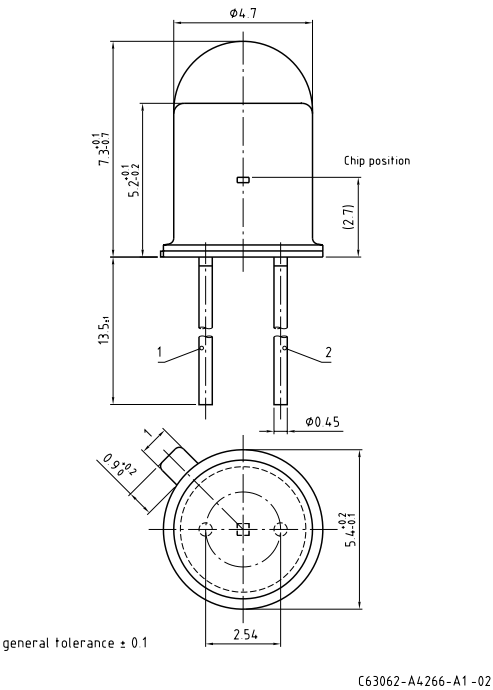
Forward current ^{6), 7)} $I_F = f(V_F)$; single pulse; $t_p = 100 \mu s$ **Relative Radiant Intensity** ^{6), 7)} $I_e/I_e(100mA) = f(I_F)$; single pulse; $t_p = 100 \mu s$ **Max. Permissible Forward Current** $I_F = f(T_A)$; $R_{th_{ja}} = 500 K/W$ **Permissible Pulse Handling Capability** $I_F = f(t_p)$; duty cycle $D = \text{parameter}$; $T_A = 25^\circ C$ 

Permissible Pulse Handling Capability

$I_F = f(t_p)$; duty cycle $D =$ parameter; $T_A = 85^\circ\text{C}$



Dimensional Drawing ⁸⁾



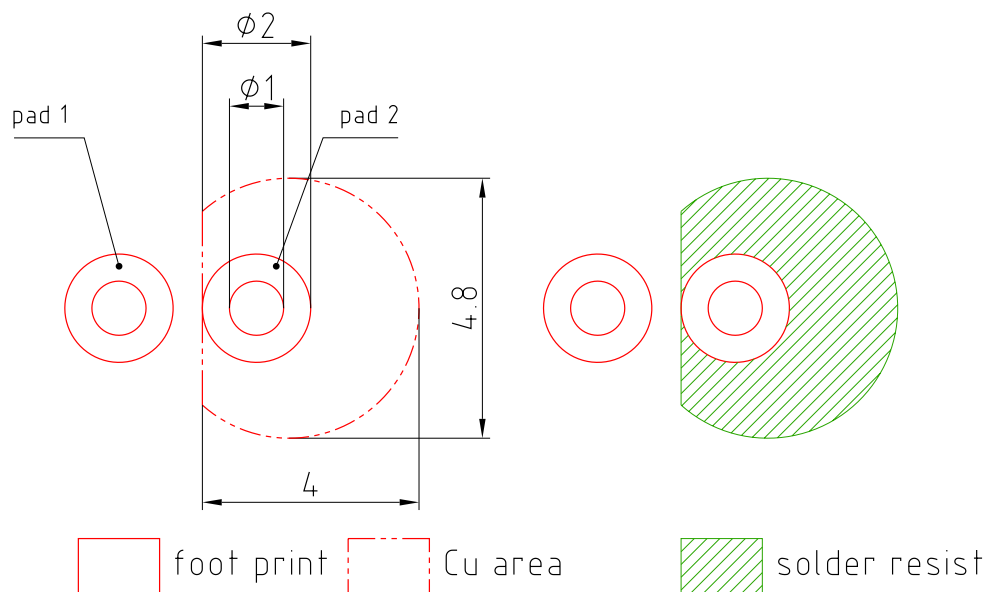
Further Information:

Approximate Weight: 380.0 mg

Package marking: Cathode

Pin	Description
1	Cathode
2	Anode

Recommended Solder Pad ⁸⁾

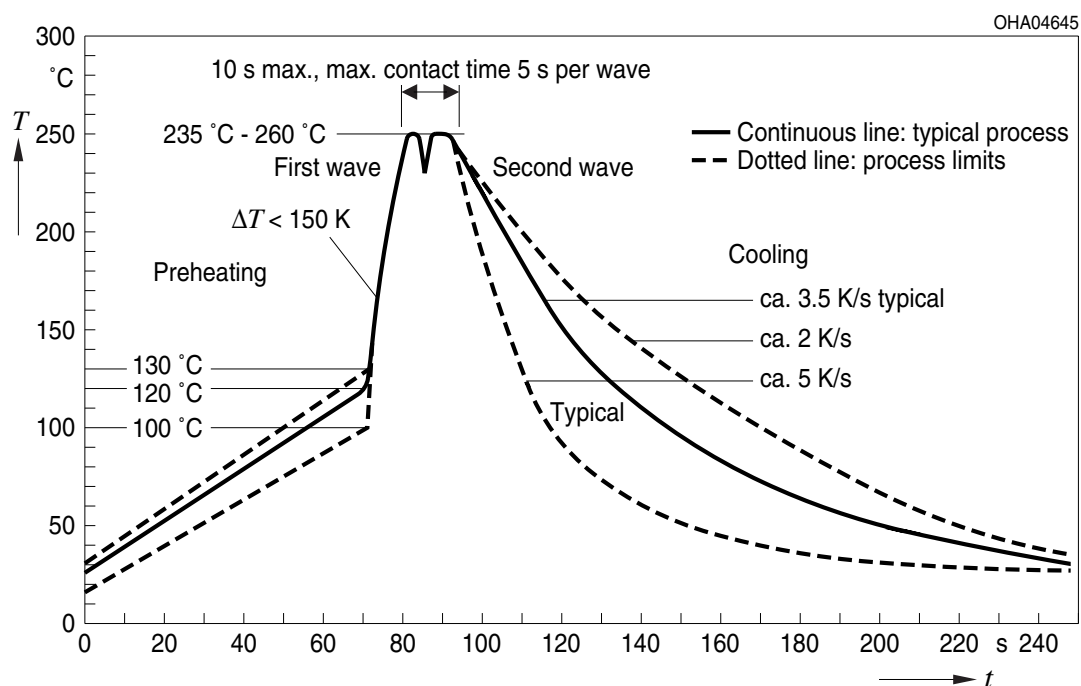


E062.3010.188-01

Pad 1: cathode

TTW Soldering

IEC-61760-1 TTW



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

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Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

- 1) **Radiant intensity:** Measured at a solid angle of $\Omega = 0.01$ sr
- 2) **Brightness:** The brightness values are measured with a tolerance of $\pm 11\%$.
- 3) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 4) **Forward Voltage:** The forward voltages are measured with a tolerance of ± 0.1 V.
- 5) **Total radiant flux:** Measured with integrating sphere.
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Testing temperature:** $T_A = 25^\circ\text{C}$ (unless otherwise specified)
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.

Revision History

Version	Date	Change
1.4	2020-02-04	Ordering Information Characteristics
1.5	2021-07-20	Maximum Ratings Characteristics
1.6	2023-01-24	Brand New Layout Applications



EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
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